



Product Change Notification

111509 - 04

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia Pacific/PRC Contact: apacgccb@intel.com

Europe Email: eccb@intel.com

Japan Email: jccb.ijkk@intel.com

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Product Change Notification

Change Notification #: 111509 - 04

Change Title: Intel® Desktop Board DZ77GA-70K & DZ77GAL-70K Boxed & Bulk
PCN 111509-04, Product Design
PCB Fab Update
Reason for Revision: The PCB Change has not yet implemented and an update will be provided at a future date.

Date of Publication: February 08, 2013

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	TBD
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Description of Change to the Customer:

Reason for Revision: The PCB Change has not yet implemented and an update will be provided at a future date.

The printed circuit board for DZ77GA70K and DZ77GAL70K will be updated to improve functionality and performance by removing Pin 10 from the Front Panel USB 3.0 connector to resolve a front panel false over current message.

Customer Impact of Change and Recommended Action:

This change has been evaluated to ensure that there is no quality, reliability or functional implication to our customers. Intel is not recommending additional qualification of these changes on platforms received from Intel.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change AA	Post Change AA
BOXDZ77GA70K	920768	G39009-402	G39009-500
BLKDZ77GA70K	920769	G39009-402	G39009-500
BOXDZ77GAL70K	923433	G39009-402	G39009-500

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
May 21, 2012	00	Originally Published PCN
September 19, 2012	01	Implementation Date Change and Include Additional SKU
December 4, 2012	02	Implementation Date Change
January 3, 2013	03	Implementation Date Change and Dash-up of Current AA#
February 8, 2013	04	The PCB Change has not yet implemented and an update will be provided at a future date.